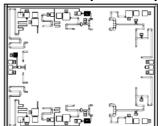
AMT2108 8 – 12GHz Power Amplifier Chip



Key Features:

Frequency: 8 – 12GHz

Typical small signal gain : 30dBTypical output power : 46dBm

• Typical power added efficiency: 42%

Supply voltage: 28V, -2V

• Chip dimensions: 4.4mm x 3.6mm x 0.1mm

• Applications: wireless communication, transceiver module, radio telecommunication etc.

Description:

AMT2108 chip is a high performance high efficiency $8-12 \, \mathrm{GHz}$ power amplifier, it is designed based on Gallium Nitrate (GaN) HEMT process, with ground through metal via on the back technology. All chip products are 100% RF tested. AMT2108 is with dual voltage supply, drain voltage Vds at 28V, it provides 46dBm output power in $8-12 \, \mathrm{GHz}$ frequency range.

Absolute Maximum Ratings (Ta = 25°C)

Symbol	Parameter	Value	Remark
Vd	Drain Voltage	35V	
Id	Drain Current	5A	
Vg	Gate Voltage	-1.6V	
lg	Gate Current	150mA	
Pd	DC Power Consumption	120W	
Pin	Input Signal Power	30dBm	
Tch	Operating Temperature	150°C	
Tm	Sintering Temperature	310°C	30s, N₂ protection

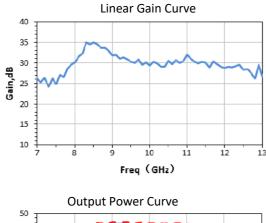
[1] Operation outside any of the Absolute Maximum Ratings may cause permanent device damage.

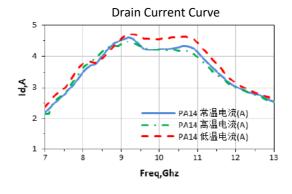
Electrical Characteristics (Ta = 25°C)

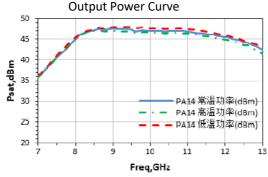
Symbol	Parameter	Parameter Test Condition Value			Unit	
			Min	Typical	Max	
Gain	Small signal gain		-	30	-	dB
VSWRin	Input standing wave	Vd = 28V	-	1.8	2	dB
Pout	Saturated output power	Vg = -2V	-	46	-	dBm
PAE	Power added efficiency	F : 8~12GHz	-	42	-	%
Id	Operating Current	Duty Cycle : 10%	-	3.5	4.3	А

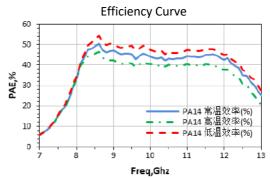
Note, under non-CW operation.

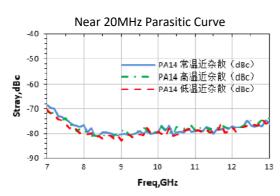
Typical Performance

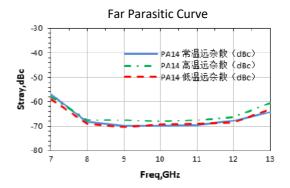




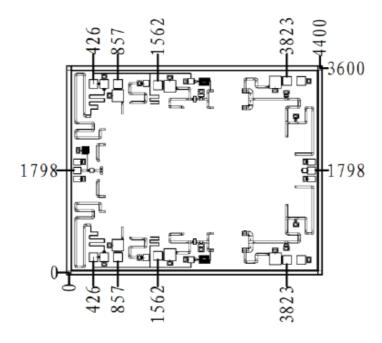




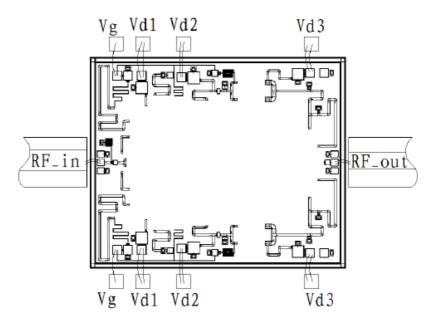




Chip Dimension (Unit: µm)



Chip Layout Diagram



Pad Definition

Symbol	Function	Dimension	Equivalent Circuit
RF_in	RF signal input port, connecting to external 50 Ω system. DC blocking capacitor is needed, if external DC current is applied to this pad.	120*110μm²	RF-in
RF_out	RF signal output port, connecting to external 50Ω system, no need to add DC blocking capacitor.	130*120μm²	RF_out
Vg	Amplifier gate bias, need external 100pF, 1000pF capacitor.	150*150µm²	Vg AHL
Vd1	Amplifier drain bias, need external 100pF, 1000pF capacitor.	150*150μm²	- Vd1
Vd2	Amplifier drain bias, need external 100pF, 1000pF capacitor.	150*150μm²	Vd2
Vd3	Amplifier drain bias, need external 100pF, 1000pF capacitor.	150*150μm²	Vd3

Please see Appendix A for details.